

股票代號：2404

漢唐集成股份有限公司 法人說明會

United Integrated Services Co. Investor Conference

2026/06/11



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- 1.漢唐集成公司簡介 (About UIS)**
- 2.營運概況說明 (Operation)**
- 3.財務狀況說明 (Financials)**
- 4.業務展望 (Future Prospects)**
- 5.Q & A**

漢唐集成成立於1982年，為一以「全面性整合服務」方式，專業提供高科技產業建廠之系統集成服務公司；主要業務範圍包括高科技廠房各系統，包括電腦、控制、無塵室、機電、電信系統之施作與整合服務。

漢唐集成的工程系統完備，服務更講求以提供整體施作方式一次滿足客戶需求。針對高科技事業建廠所需之無塵室系統、機械系統、電氣系統、配管系統、製程支援系統、儀錶及控制系統、通訊系統、生命安全系統、門禁及安全管理系統、大宗及特殊氣體系統、超純水（UPW）及再生系統、超純水回收系統、廢水處理與製程化學品輸送，及二次配管路工程等系統，均囊括在漢唐集成的服務範圍內。

漢唐集成就以上各項系統提供從採購、施工、試車、移交、保固到維護保養的服務，過程中並實施深化業主需求、提高施工品質的服務，以科技方式整合以上各項系統工程，達成介面統一，使客戶完全無需擔憂各個不同系統之間的介面整合問題；漢唐集成是國內目前具備系統工程整合技術及能力且有實績有信譽的廠商，並獲得業主及業界多次的授獎及讚譽。

United Integrated Services Co., Ltd is a multidisciplinary engineering and construction company capable of overall systems coordination. We provide fully integrated design/build services to our clients in the high technology industry for their manufacturing facility needs.

Our scope of services includes high-tech factory construction, where clean-room systems, HVAC, electrical systems, instrumentation and control, process utilities, telecommunication systems, and tool hook-up are all vital components requiring total coordination.

UIS provides integrated services encompassing procurement, construction, testing, handover, warranty, and maintenance for all the aforementioned systems. Throughout the process, we deepen client requirements, enhance construction quality, and integrate these systems using technology, ensuring interface uniformity and eliminating concerns regarding integration issues between different systems.

In short, we strive to be a one-stop shop to satisfy our clients' every facility need. Our company is one of the few domestic firms with the technical expertise, capabilities, and achievements in system engineering integration, enjoying multiple awards and accolades from clients and the industry.

漢唐科技工程有
限公司成立
Company
Established

申請掛牌上市
(股票代號 2404)
IPO

成立江西漢唐系統
集成有限公司
Established UIS,
Jiang Xi

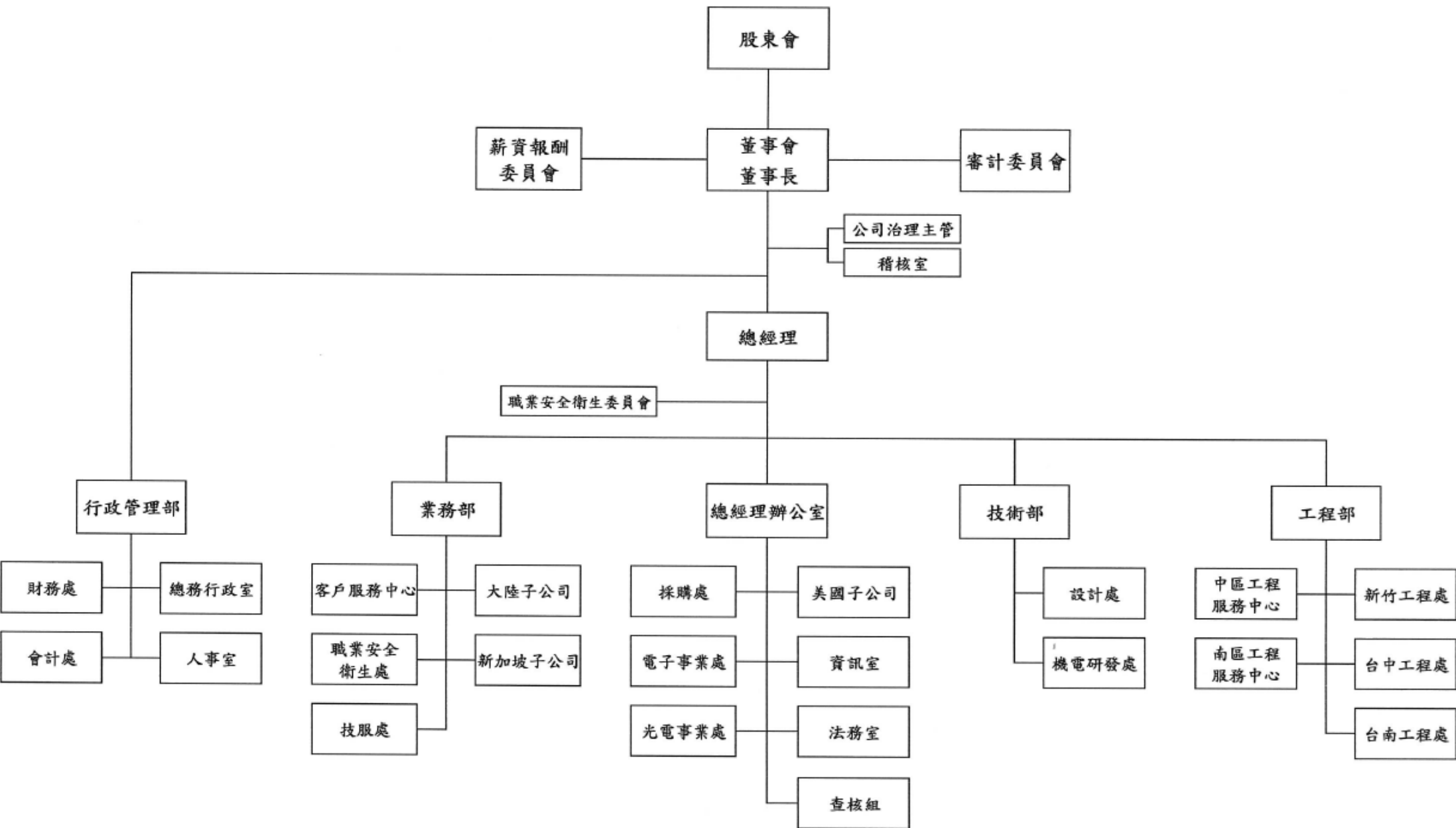
成立美國漢唐
集成公司
Established
UIS USA



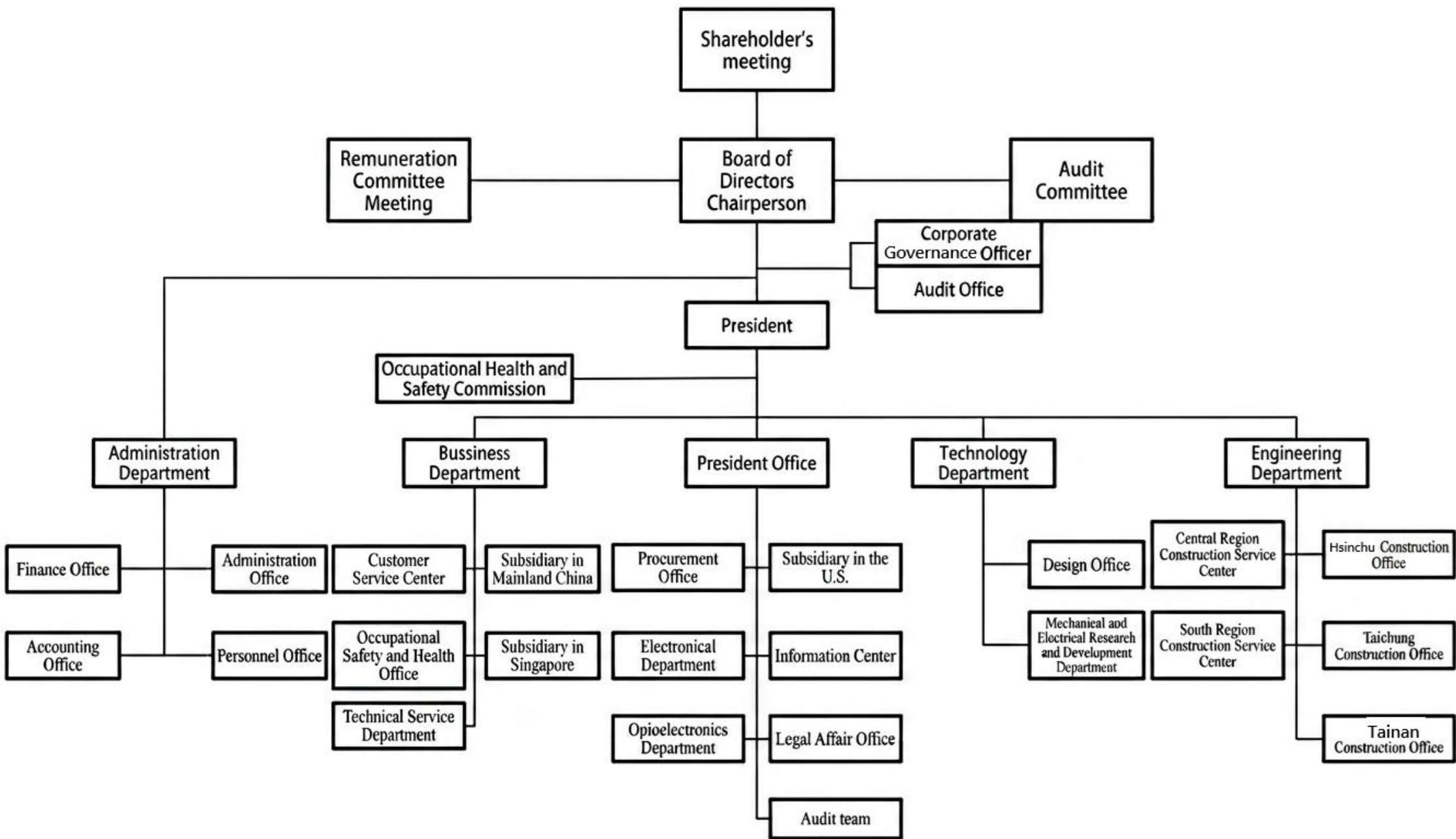
合併訊聯系統股份有限公司並
更名為漢唐訊聯股份有限公司
Acquired United Information
Systems

申請更名為漢唐集成股份有
限公司
Changed name to United
Integrated Services

成立新加坡漢唐私人有限
公司
Established UIS,
Singapore



UIS 公司組織表



UIS客戶群(UIS Clients)

★ **Main office**
Zhonghe

● **Branch office and Service Locations**

Hsinchu
Taichung
Tainan
Shanghai
Nanjing
Hefei
Shenzhen
Singapore
Arizona

日本熊本 關鍵材料設備供應

● tsmc FAB 23P1

南京
合肥
上海

深圳

熊本

Arizona 鳳凰城

美國亞利桑那州

● F21P1, P2

Hsinchu

- tsmc FAB 12 P5, P6,P7,P8
 - tsmc FAB 20 P1,P2,P3
- Longtan**
- QPM FAB C (TSMC BP03)

Taichung

- tsmc FAB 15 P1- P7
- Micron FAB A2,A3
- auo L8B FAB
- tsmc Solar
- Micron AATT (TCP2)
- Micron AATT2 (MAKO)
- tsmc AP5B

Chiayi

- tsmc AP7P1 MEP, AP7P2

Tainan

- tsmc FAB 14 P4- P7
- tsmc FAB 18 P1- P8
- tsmc AP8P1
- Micron Falcon A, 200K

Kaohsiung

- tsmc FAB 22 P1,P2,P3

新加坡

Singapore

● VSMC P1 CR

■ 工程承包範圍 Scope of Engineering

- 無塵室工程
Cleanroom
- 機電工程
Mech. / Elec. Engineering
- 水氣化等特殊系統工程
UPW / WWT / Gas / Chem.
Systems
- 監控系統工程
I&C

■ 服務範圍 Scope of Services

- 工程施工
Construction
- 售後服務
After Sale Services

台灣積體電路製造股份有限公司

台積電三廠

台積電四廠

台積電六廠

台積電十二廠 P1, P2, P3, P4, P5, P6, P7, P8

台積電十四廠 P1, P2, P3, P4, P5, P6, P7

台積電十五廠 P1, P2, P3, P4, P5, P6, P7

台積電十八廠 P1, P2, P3, P4, P5, P6, P7, P8

台積電南京廠 F16P1 P2

台積電龍潭 BP03

台積電美國F21P1, P2

台積電日本F23 (關鍵材料設備供應)

台積電二十廠 P1, P2, P3

台積電二十二廠 P1, P2, P3

台積電封測五廠 AP5B

台積電封測七廠 AP71 MEP, AP7P2

台積電封測八廠 AP8

華邦電子股份有限公司

華邦 FAB I, FAB II, FAB III, FAB IV

華邦 FAB CTSP, FAB 6C

旺宏電子股份有限公司

旺宏 FAB I, FAB II, FAB III

台灣美光記憶體股份有限公司

美光 FAB A1 A2 A3 A3M2a A3M2b

美光 AATT (TCP2), AATT2 (MAKO)

美光 Falcon A, 200K

世界先進積體電路股份有限公司

VSMC P1 CR

力晶半導體股份有限公司

力晶 FAB 8A, P3, P4, P5

Taiwan Semiconductor Manufacturing Company Ltd.

TSMC FAB III

TSMC FAB IV

TSMC FAB VI

TSMC FAB XII P1, P2, P3, P4, P5, P6, P7, P8

TSMC FAB XIV P1, P2, P3, P4, P5, P6, P7

TSMC FAB XV P1, P2, P3, P4, P5, P6, P7

TSMC FAB XVIII P1, P2, P3, P4, P5, P6, P7

TSMC China Nanjing F16 P1, P2

TSMC BP03

TSMC USA F21 P1, P2

TSMC F20 P1, P2, P3

TSMC F22 P1, P2, P3

TSMC AP5B

TSMC AP71 MEP, AP7P2

TSMC AP8

Winbond Electronics Corp

Winbond FAB I , FAB II , FAB III , FAB IV

Winbond FAB CTSP, FAB 6C

Macronix International Co., Ltd

MXIC FAB I , FAB II, FAB III

Micron Memory Taiwan Co., Ltd.

Micron FAB A1 A2 A3 TCP2 A3M2a A3M2b

Micron AATT (TCP2), AATT2 (MAKO)

Micron Falcon A, 200K

VisionPower Semiconductor

Manufacturing Company Pte. Ltd.

VSMC P1 CR

Powerchip Technology Corporation

PSC FAB 8A , P3 , P4, P5

友達光電股份有限公司

友達 FAB L3C

友達 FAB L3D (QDI Line I)

友達 FAB L4A

友達 FAB L5A

友達 FAB L5B

友達 FAB L5C

友達 FAB L5D (QDI Line II)

友達 FAB L6A

友達 FAB L6B (QDI Line III)

友達 FAB L7A, L7B

友達 FAB L8A, L8B

奇美電子股份有限公司

奇美 FAB 三廠

奇美 FAB 四廠

奇美 FAB 五廠

奇美 FAB 六廠

奇美 FAB 七廠

奇美 FAB 八廠

高通液晶顯示器股份有限公司

高通 FAB C

群創光電股份有限公司

Innolux T2廠

瀚宇彩晶股份有限公司

瀚宇彩晶 FAB I, FAB II

瀚宇彩晶 FAB III, FAB IV

AU Optronics Corp.

AUO FAB L3C

AUO FAB L3D (QDI Line I)

AUO FAB L4A

AUO FAB L5A

AUO FAB L5B

AUO FAB L5C

AUO FAB L5D (QDI Line II)

AUO FAB L6A

AUO FAB L6B (QDI Line III)

AUO FAB L7A, L7B

AUO FAB L8A, L8B

Chi Mei Optoelectronics Corp.

CMO FAB III

CMO FAB IV

CMO FAB V

CMO FAB VI

CMO FAB VII

CMO FAB VIII

Qualcomm Panel Manufacturing Ltd.

QMP FAB C

Innolux Corporation

Innolux T2

HannStar Display Corp.

HannStar FAB I, FAB II

HannStar FAB III, FAB IV

近五年盈餘分配狀況

Income Statement

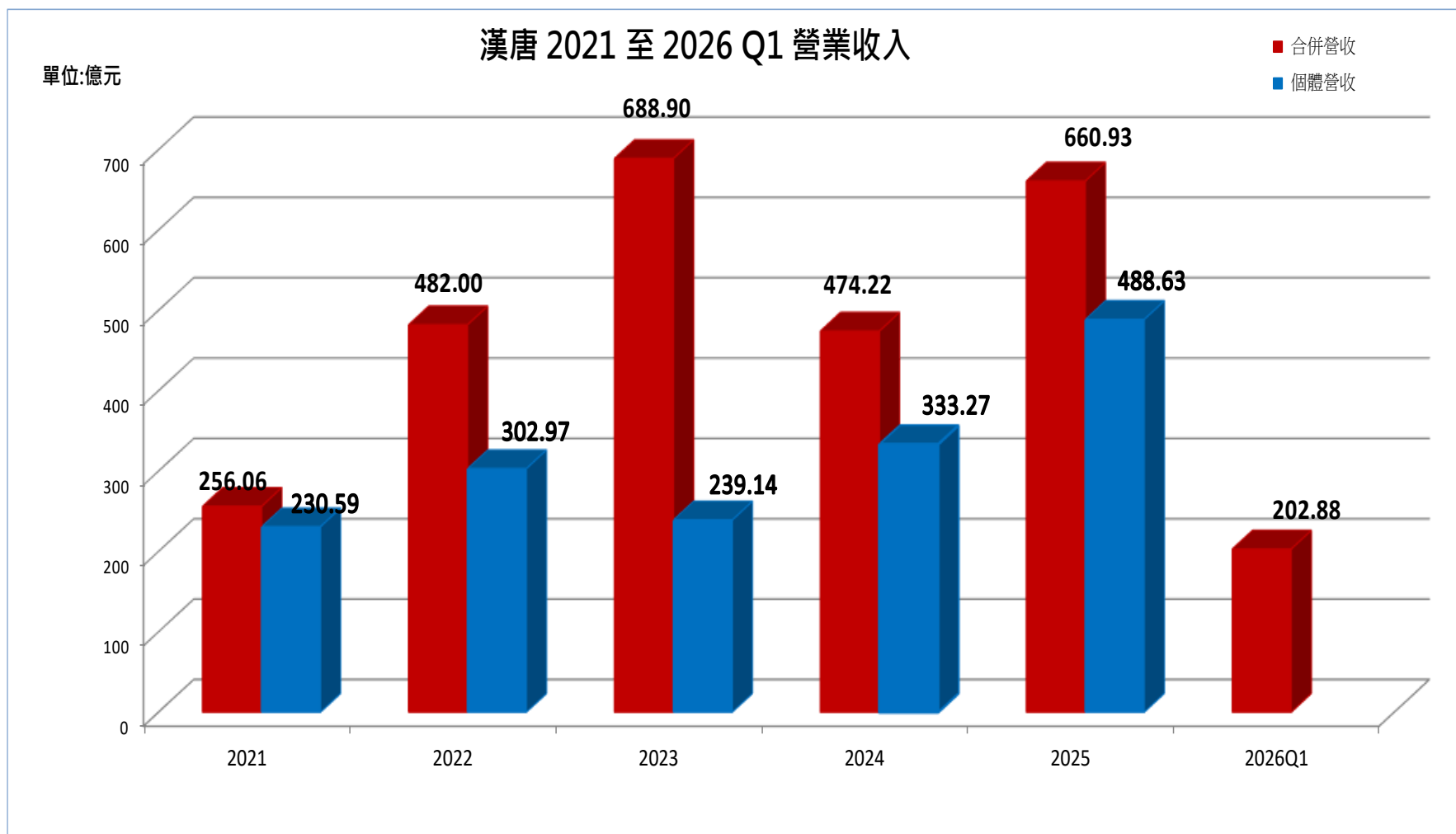
	110年 (2021)	111年 (2022)	112年 (2023)	113年 (2024)	114年 (2025)	115年Q1 (2026Q1)
營業收入(千元) Rev.(thousand)	25,606,141	48,200,310	68,889,680	47,421,600	66,093,193	20,288,456
毛利(千元) Gross Profit(thousnad)	4,086,636	6,718,724	7,531,191	8,512,585	13,229,910	4,731,351
毛利率 Gross Profit %	15.96%	13.94%	10.93%	17.95%	20.02%	23.32%
本期稅後損益(千元) EAT(thousand)	2,820,482	4,101,845	4,847,498	6,263,271	9,165,572	3,087,011
每股盈餘(元) EPS	14.53	21.25	24.82	32.94	48.08	16.31
現金股利(元) Cash Dividends	13.00	15.00	21.00	28.00	40.00	
股利發放率 Dividend Payout Ratio	89.47%	70.59%	84.61%	85.00%	83.19%	
負債佔資產比率 Debt Asset Ratio	58.88%	68.30%	73.25%	67.96%	76.06%	
流動比率 Current Ratio	143.61%	132.50%	128.24%	138.62%	126.93%	
純益率 Net Profit Margin	11.01%	8.51%	7.04%	13.21%	13.87%	

近五年營收 (Revenue)

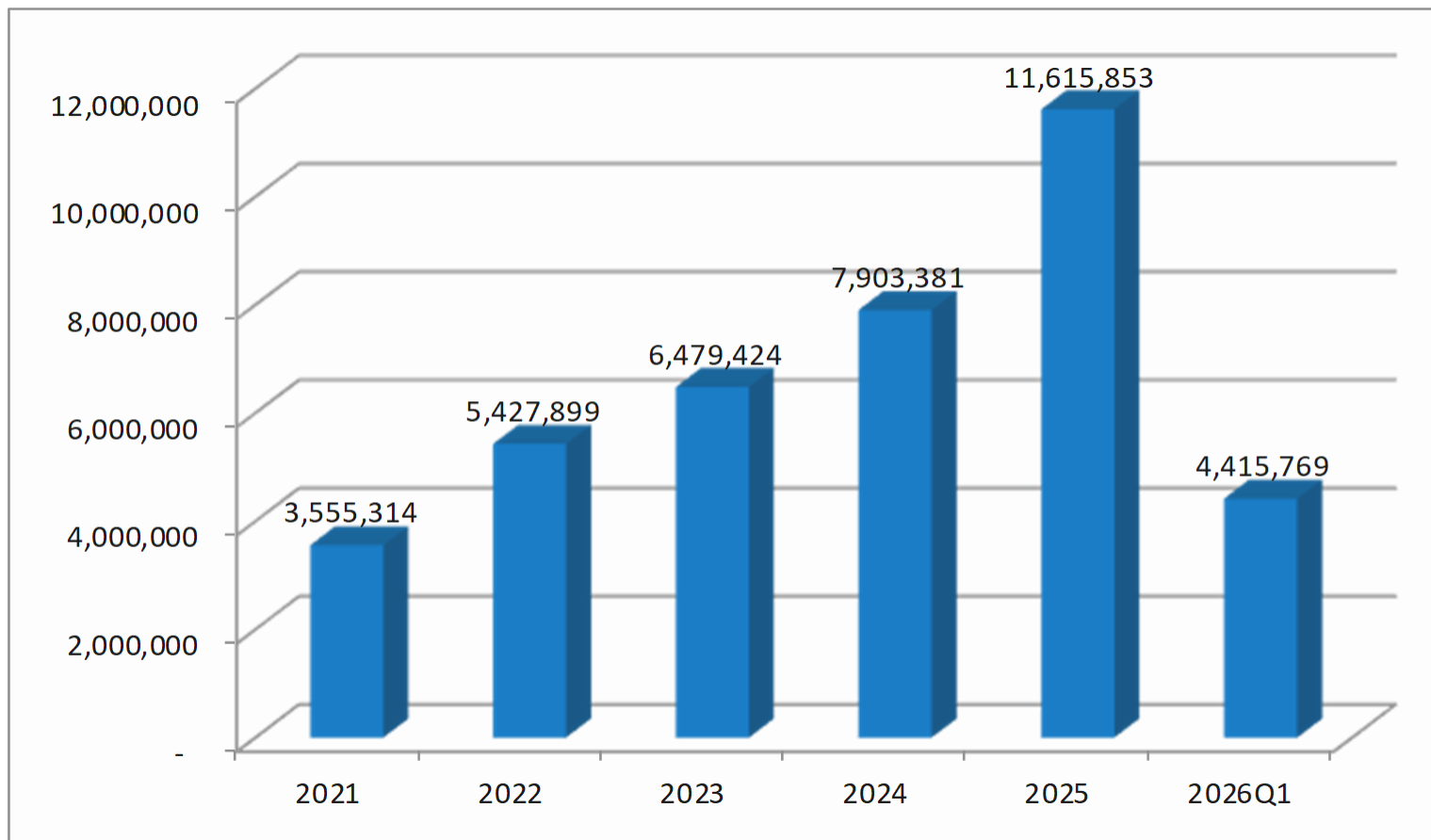
Unit: NTD 100 million 單位：億元

■ 個體營收

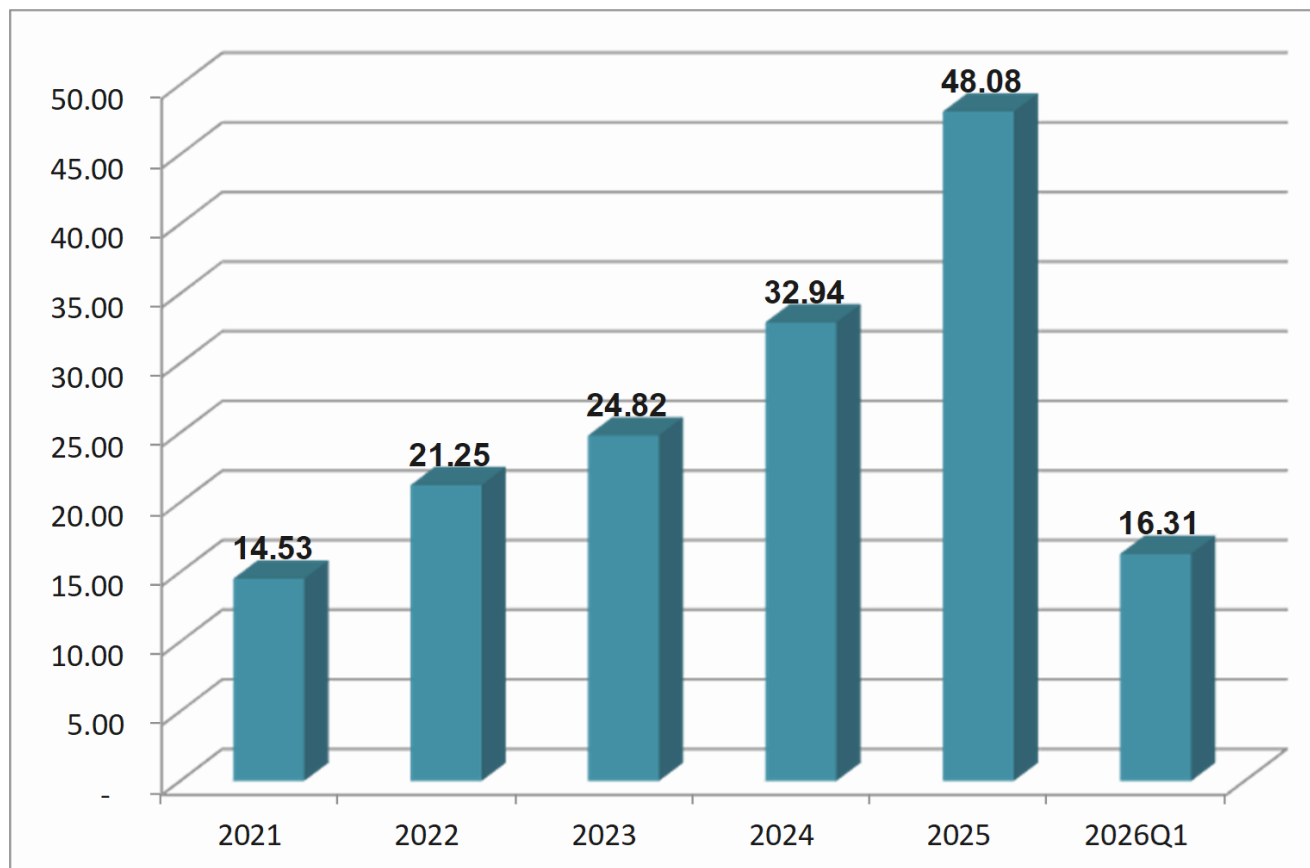
■ 合併營收



稅前淨利 (EBIT)



每股盈餘 (EPS)



累計接單狀況統計

Business in total

➤ 115年接單合約金額(1~05月份)

2026 Contract Value **NTD 67,414,390 仟元**

➤ 115年1月至05月累計營收

Accumulated Rev. **NTD 37,613,140 仟元**
(from Jan. to May)

➤ 截至115年05月已簽約未認列之金額

Accumulated **NTD 193,937,271 仟元**
Account Receivable
(to May)

115年Q1合併資產負債表

2026 Q1 Consolidated Balance Sheet

單位:仟元
Unit: thousand

	115/3/31	114/12/31	114/3/31		115/3/31	114/12/31	114/3/31
現金及約當現金 Cash	30,246,120	29,928,325	15,448,196	銀行借款 Bank loan			-
				應付帳款 PA	8,722,985	9,662,093	7,656,357
合約資產 Contract assets-current	9,337,694	9,071,755	5,868,615	合約負債 Contract liabilities	48,264,643	45,433,627	30,305,092
其他流動資產 Others	40,418,009	35,746,208	34,105,481	其他流動負債 Others	12,809,768	3,792,803	8,830,915
流動資產合計 Total Current Assets	80,001,823	74,746,288	55,422,292	流動負債合計 Total Current Liabilities	69,797,396	58,888,523	46,792,364
不動產、廠房及設備 PPE	2,642,219	1,346,766	1,349,148	其他非流動負債 Others	1,005,050	1,066,994	970,060
其他非流動資產 Others	2,799,162	2,729,908	2,623,064				
非流動資產合計 Total Non-current Assets	5,441,381	4,076,674	3,972,212	負債總計 Total Liabilities	70,802,446	59,955,517	47,762,424
				股東權益總計 Total SE	14,640,758	18,867,445	11,632,080
資產總計 Total Assests	85,443,204	78,822,962	59,394,504	負債及權益總計 Total Liabilities+SE	85,443,204	78,822,962	59,394,504

若本簡報引述的財務資料，與已對外公告的財務報告有不符的情形，以已對外公告的財務報告的內容為主。

If there is any conflict between, or any difference in the financial information quoted in this presentation and the announced financial report, the announced financial report shall prevail

115年Q1及114年合併損益表

2026 Q1 & 2025 Consolidated Income Statement

單位:仟元
Unit: thousand

	115年1月至3月 2026 Jan.~Mar.		114年1月至12月 2025 Jan.~Dec.		114年1月至3月 2025 Jan.~Mar.	
營業收入 Revenue	20,288,456	100%	66,093,193	100%	11,517,514	100%
營業成本 Cost	15,557,105	77%	52,863,283	80%	8,844,438	77%
營業毛利 Gross Profit	4,731,351	23%	13,229,910	20%	2,673,076	23%
營業費用 Operating expenses	761,070	3%	2,242,126	3%	479,802	4%
營業淨利 Operating Income	3,970,281	20%	10,987,784	17%	2,193,274	19%
營業外收入淨額 Net non-operating income	445,488	2%	628,069	1%	361,118	3%
稅前淨利 EBIT	4,415,769	22%	11,615,853	18%	2,554,392	22%
所得稅費用 Income Tax	1,328,758	7%	2,450,281	4%	538,978	5%
本期淨利 Net Income	3,087,011	15%	9,165,572	14%	2,015,414	17%
本期淨利歸屬於母公司 Net Income (Parent company)	3,081,118	15%	9,069,393	14%	1,989,414	17%
綜合損益歸屬於母公司 Composite Net Income (Parent Company)	3,315,630	16%	8,996,398	14%	1,940,096	17%
基本每股盈餘 EPS	16.31		48.08		10.55	
稀釋每股盈餘 Diluted EPS	16.19		47.73		10.49	

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一一五年，漢唐預期將全面受惠於全球半導體產業、以 AI 應用為核心的結構性投資浪潮。隨著 AI 技術和應用的快速延伸，高效能運算（HPC）晶片與記憶體需求持續攀升，已成為推動先進製程、先進封裝與高科技廠房投資的關鍵動能。

主要客戶預計於一一五年初陸續啟動多座晶圓廠之投資計畫，布局範圍除涵蓋全台灣主要科技聚落，海外亦有積極擴廠行動及技術升級，相關建廠需求具規模大且延續性高之特性，為本公司營運帶來穩定且可預期的成長機會。面對龐大且密集的工程需求，漢唐將提前強化技術團隊與人力資源配置，並同步優化供應鏈管理與風險控管機制，以提升整體專案執行彈性與交付能力。

展望一一五年，儘管全球經濟仍可能受地緣政治與政策變化影響，本公司將憑藉訂單管理能力、跨區域經驗及供應鏈整合彈性，展現穩健的經營韌性。未來營運重點將不僅著眼於營收規模成長，更將聚焦於獲利結構優化與風險控管能力提升。轉化產業成長動能為長期且穩定的企業價值，為股東創造永續回報。

In 2026, UIS expects to fully benefit from the structural investment wave in the global semiconductor industry, which is centered around AI applications. Driven by the rapid expansion of AI technologies and applications, the demand for High-Performance Computing (HPC) chips and memory continues to climb, serving as a pivotal momentum accelerating investments in advanced nodes, advanced packaging, and high-tech facility construction.

Key clients are projected to progressively initiate investment plans for multiple fabs starting early 2026. This layout spans major technology clusters across Taiwan, alongside aggressive overseas expansions and technological upgrades. These facility construction demands are characterized by large scale and high continuity, presenting stable and predictable growth opportunities for our operations. In response to the massive and intensive engineering demands, UIS will proactively strengthen technical teams and human resource allocation, while concurrently optimizing supply chain management and risk control mechanisms to enhance overall project execution flexibility and delivery capabilities.

Looking ahead to 2026, despite potential global economic headwinds stemming from geopolitics and policy shifts, the Company will leverage its order-book management capabilities, cross-regional expertise, and supply chain integration flexibility to demonstrate robust operational resilience. Our future operational focus will expand beyond mere revenue growth, sharpening its focus on optimizing profitability structure and enhancing risk control capabilities. We aim to translate industry growth momentum into long-term, stable corporate value, creating sustainable returns for our shareholders.

Thank You

Q & A